



Second ECFA Workshop on e+e- Higgs/EW/Top Factories

# Noble Liquid Calorimetry for Future Collider Experiments

a.k.a. ALLEGRO detector concept & ECAL development

Juska Pekkanen

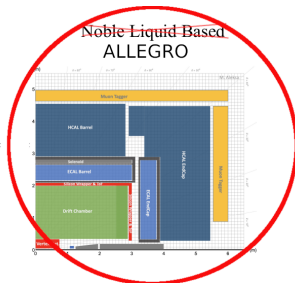
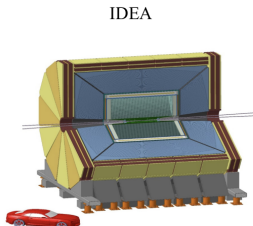
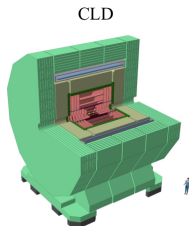
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CERN

October 11, 2023

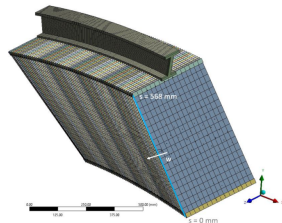
# Outline

- ▶ ALLEGRO detector concept
- ▶ Noble liquid calorimetry
- ▶ Read-out electrode prototype & cross-talk studies
- ▶ Mechanical design
- ▶ Software & performance studies
- ▶ Conclusions & outlook





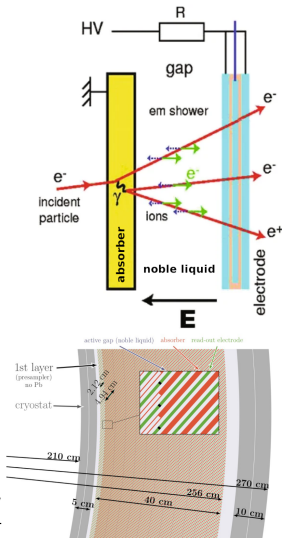
# ALLEGRO detector concept

- ▶ General-purpose detector for FCC-ee
- ▶ Recently coined as ALLEGRO by a vote
  - A Lepton coLLider Experiment with Granular calorimetry Read-Out
- ▶ Concept built around a highly-granular noble liquid ECAL
  - LAr or LKr with Pb or W absorbers
  - Multi-layer PCB as read-out electrode
- ▶ Vtx detector, drift chamber and ECAL inside 2T solenoid, sharing cryostat
- ▶ CALICE or TileCal like HCAL and muon system outside solenoid
- ▶ Optimized for full FCC-ee physics program
  - Focus on PFlow & particle ID performance



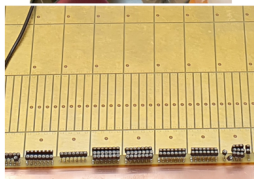
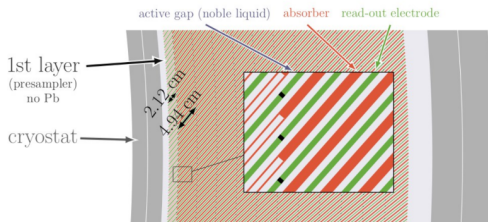
# Refresher on noble liquid calorimetry

- ▶ Sampling calorimetry relying on ionization
- ▶ Based on alternating layers of absorbers, noble liquid and read-out electrodes
  - Voltage applied over noble-liquid gap
  - Incident particle ionizes noble liquid
  - $e^-$  drift to electrodes for signal pick-up
- ▶ Successfully applied in a number of HEP experiments
  - MarkII, DØ  , H1, NA48/62, ATLAS 
- ▶ Excellent E resolution, linearity, stability and uniformity, good timing properties
- ▶ Challenges: complex mechanical structure inside cryostat, signal feed-thru, granularity



# Highly granular noble-liquid calorimeter

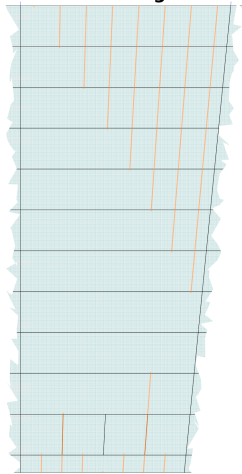
- ▶ Printed circuit board (PCB) technology allows "arbitrarily" high granularity
  - Signal traces inside the electrode
- ▶ Prototype PCB 58 cm × 44 cm →
  - 50° inclination, 40 cm ( $22 \chi_0$ ) thick
  - Split to 16  $\theta$ -towers & 12 depth layers
  - Narrow strips in front for  $\pi^0$  detection
- ▶ 7-layer PCB, complex internal structure
- ▶ 240 cells in total in the first prototype
- ▶ Read-out from inner and outer edge



# Readout electrode structure & shielding

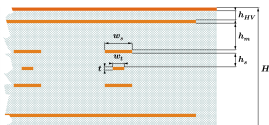
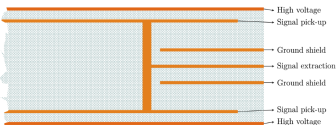
- ▶ Signal traversing under other cells induces *cross-talk* (x-talk)
- ▶ Can be mitigated by shielding signal traces with grounded strips
- ▶ Trade-off between x-talk and electronics noise
  - More shields, smaller x-talk
  - More shields, more electronics noise
- ▶ In PCB v0 baseline is 2x width shields above and below each signal trace
  - Other configurations implemented for studies

$\theta = 90^\circ$  **Outer edge**  $\theta = 89.43^\circ$



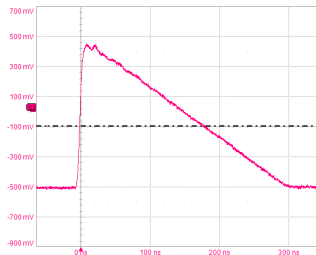
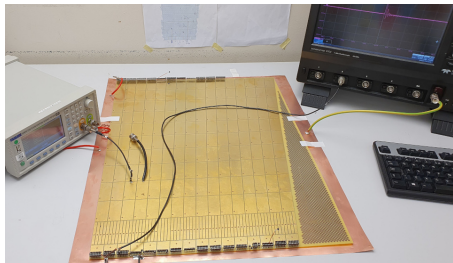
**Inner edge**

<--- Stretched x10 --->

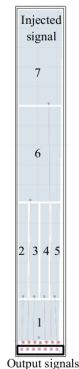
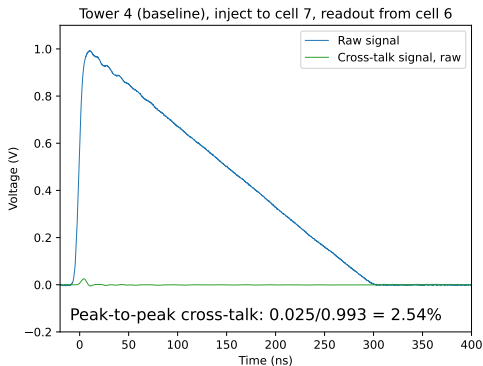


# PCB measurement setup

- ▶ Electrical properties of the PCB measured with a simple table-top setup
- ▶ Function generator used for injecting sharp-edged triangular signal
  - 300 ns wide 1 V peak with long (5 ms) period
- ▶ Signal read with oscilloscope, analyzed offline
- ▶ Extra care taken for ensuring good quality measurements
  - Short cables, thorough grounding, termination of signal strip, impedance matching



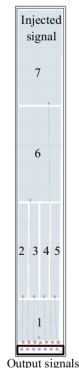
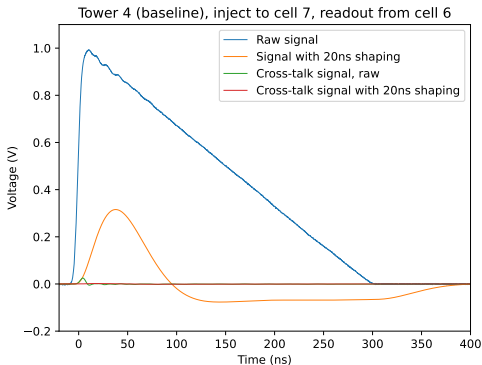
# PCB measurements



- ▶ Compare main signal magnitude to x-talk signal
- ▶ X-talk measured as "peak-to-peak" ratio
- ▶ X-talk ratio of  $<1\%$  is needed and achieved with *shaping* →

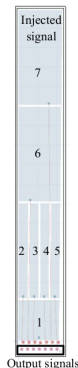
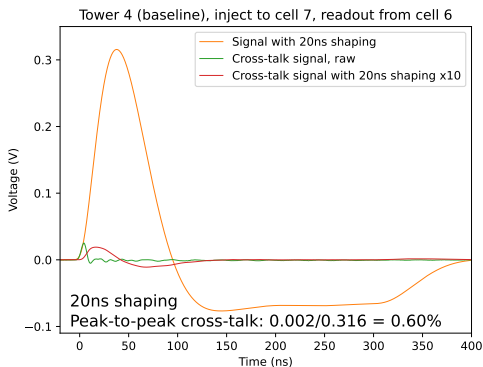


# PCB measurements



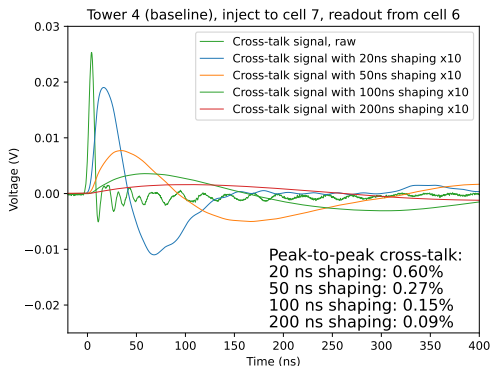
- ▶ Shape signals with ATLAS-style CR-RC<sup>2</sup> shaper
  - Here modeled by an analytical function
  - In reality implemented with electronics
  - Other shaping functions will be studied
- ▶ After shaping x-talk signal too small to see

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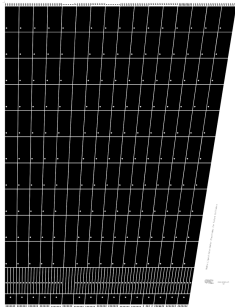
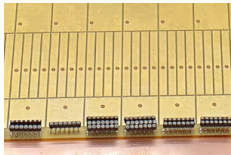
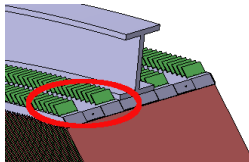
# Cross-talk and shaping time



- ▶ Longer shaping time gives lower x-talk in  $e^+e^-$  conditions
  - At LHC long shaping times not good due to pileup
- ▶ Cross-talk goes down to 0.1% with 200 ns shaping
- ▶ Here only one pair of cells, more studies to be done

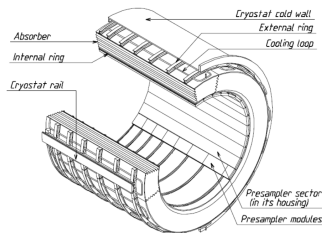
# Plans for next PCB prototype

- ▶ Simulation studies underway for optimizing granularity
- ▶ Read-out from outer edge only for minimizing material bulk
  - Signal-to-cross-talk ratio of narrow strip layers a challenge due to smaller main signal
  - Singnal traces need to be "funneled" thru support structure
  - Will increase "trace-to-trace" cross-talk
- ▶ Would only one shield per signal strip be sufficient?
  - 6-layer PCB cheaper to manufacture
  - Thinner PCB increases sampling ratio
- ▶ Better solution to read-out connection
  - Industry standard connector?

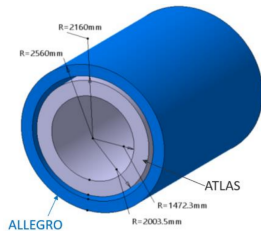


# Mechanical studies

- ▶ ATLAS LAr ECAL used as reference
  - Larger radius, new electrode geometry
- ▶ Finite element analysis used for structural element design (strength, size)
- ▶ First prototype of two absorbers and one electrode was built
  - Tested in liquid nitrogen bath, no permanent damages found



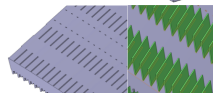
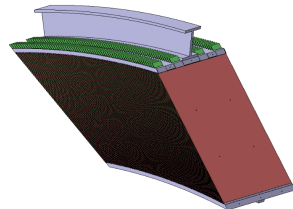
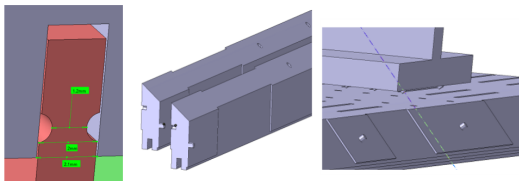
ATLAS liquid argon calorimeter general layout



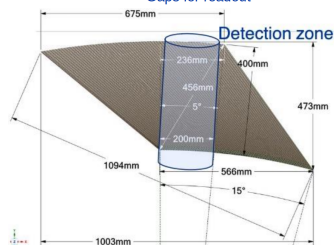
Calorimeter size comparison

# Test-beam prototype

- ▶ Design of a test beam prototype to be frozen by September 2024
  - 64 electrodes and absorbers
  - Placed in a cryostat for beam tests
- ▶ 3D-printed prototype in development
  - Easy to produce and improve test parts
  - Design can be used as basis for real parts
  - Helps also in visualizing complex structure

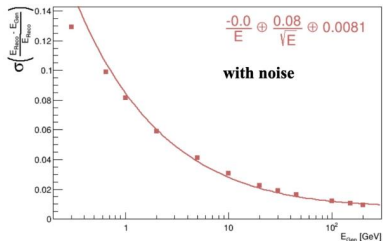
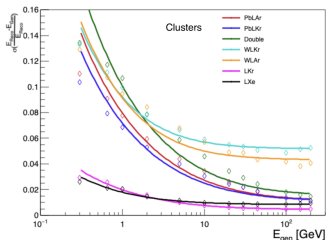
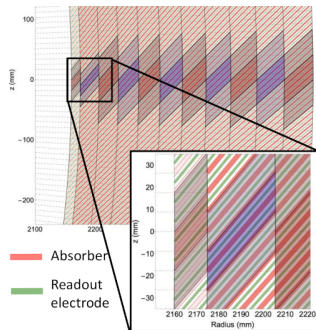


Gaps for readout



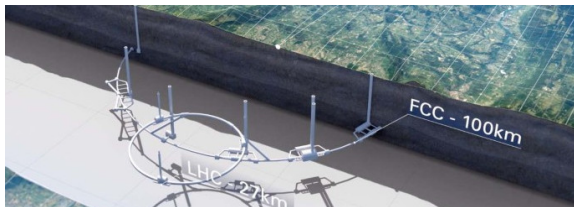
# Software & Performance studies

- ▶ Full detector simulation in development in the FCC-SW in the Key4hep framework
  - Crucial already in early planning state for performance studies before test beam
- ▶ More on SW today at 4pm & Friday at 9am
  - Talks by Alvaro Delgado & Brieuc François
- ▶ Some performance studies already done, much more to be done
  - Materials, inclination, granularity, ...



# Conclusions & Outlook

- ▶ ALLEGRO is a multi-purpose detector concept for FCC-ee
- ▶ Multi-layer PCB allows high-granularity NL calorimetry
  - Good option for future  $e^+e^-$  experiments
  - Also excellent choice for hadron colliders
- ▶ New prototype PCB design in 3-4 months
  - Smaller prototype PCB coming earlier to IJCLab in Paris
- ▶ Test-beam prototype with 64 layers in development
  - Design ready by 9/2024, then need to build it...
- ▶ Draft web page done, to be published within next months
- ▶ Team is growing fast, more people always welcome!





# Back-up



FUTURE  
CIRCULAR  
COLLIDER

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17/19

